

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6274618

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAIPING DUN	12/22/2017
HUNG-CHEN LIN	12/22/2017
HO-YUAN YU	12/22/2017
RECEIVING PARTY DATA	
Name:	CHAMPION MICROELECTRONIC CORP.
Street Address:	5F, NO. 11, PARK AVENUE 2, HSINCHU SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Name:	YUTECHNIX, INC.
Street Address:	19308 VENDURA CT.
City:	SARATOGA
State/Country:	CALIFORNIA
Postal Code:	95070
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16939022
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	charles.cheng@chengipg.com
Correspondent Name:	CHARLES T. CHENG
Address Line 1:	1583 CLARKSPUR LANE
Address Line 4:	SAN JOSE, CALIFORNIA 95129
ATTORNEY DOCKET NUMBER:	P2016002-US-DIV1
NAME OF SUBMITTER:	CHARLES T. CHENG
SIGNATURE:	/Charles T. Cheng/
DATE SIGNED:	08/31/2020

Total Attachments: 6

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ASSIGNMENT OF APPLICATION FOR PATENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, does hereby SELL, ASSIGN AND TRANSFER to:

Champion Microelectronic Corp.

(the "Assignee"), having its principal place of business at the following address:

5F, No. 11, Park Avenue 2, Hsinchu Science-Based Industrial Park,
Hsinchu, Taiwan, R.O.C.

their entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and is entitled, DEEP TRENCH MOS BARRIER JUNCTION ALL AROUND RECTIFIER AND MOSFET, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing.

maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

COVENANT AND AGREE that the above is and will be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

(Signature) *Haiping Dun*
Name: Haiping Dun

Date: 12/22/2017

Customer ID #85897
Cheng Intellectual Property Group
1583 Clarkspur Lane,
San Jose, CA 95129

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(Signature) Hung-Chen Lin
Name: Hung-Chen Lin

Date: _____

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Cheng Intellectual Property Group
1583 Clarkspur Lane,
San Jose, CA 95129

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Yutechnix, Inc.

(the "Assignee"), having its principal place of business at the following address:

19308 Vendura Ct.,
Saratoga, CA 95070, U.S.A.

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(Signature) Ho-Yuan Yu
Name: Ho-Yuan Yu

Date: 11-22-2017

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Cheng Intellectual Property Group
1583 Clarksburg Lane,
San Jose, CA 95129